

Low Profile SMD Schottky Barrier Rectifiers

**Package: SOD-123H / MINI SMA
 (Molded Plastic)**

Reverse Voltage: 20 to 100 Volts

Forward Current: 2.0 Amps

RoHS Device

Halogen Free

**Excellent power dissipation offers
 better reverse leakage current and
 thermal resistance**

**Low profile package is 40%
 thinner than standard SOD-123
 package**

Low power loss, high efficiency

**High current capability, low
 forward voltage drop.**

High surge capability

**Guarding for over voltage
 protection**

Ultra high-speed switching

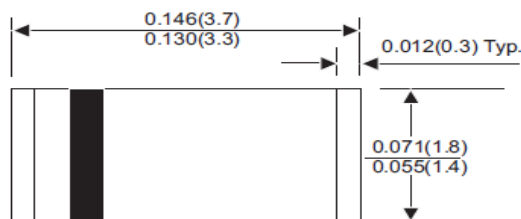
**Silicon epitaxial planar
 chip, metal silicon junction.**

**Lead-free part meets
 environmental standards of
 MIL-STD-19500/228**

Comchip's CDBMT Schottky barrier rectifier series utilizes the low profile flat chip SOD-123H (MINI SMA) package. The SOD-123H measures just: 1.6mm(w) x 3.5mm(l) x 0.8mm(h). The slim package design makes the CDBMT series ideal for components of DC power supplies and high-voltage direct current power transmission systems. With today's market demanding smaller and thinner products, Comchip is striving to exceed market demands with quality products at a conveniently low price. With a forward current of 2 amps, reverse voltage applications range from 20 to 100 volts.



SOD-123H



Dimensions in inches and (millimeter)

Epoxy: UL94-V0 rated flame retardant

Terminals: Solderable per MIL-STD-750, Method 2026

Polarity: Indicated by cathode band

Mounting Position: Any

Weight: 0.011 grams

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Maximum Ratings (at $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	CDBMT 220-HF	CDBMT 230-HF	CDBMT 240-HF	CDBMT 250-HF	CDBMT 260-HF	CDBMT 280-HF	CDBMT 2100-HF	Unit
Repetitive peak reverse voltage	V _{RRM}	20	30	40	50	60	80	100	V
Continuous reverse voltage	V _R	20	30	40	50	60	80	100	V
RMS voltage	V _{RMS}	14	21	28	35	42	56	70	V
Forward rectified current	I _O	2.0							A
Maximum forward voltage @ I _F =2.0A	V _F	0.50			0.70		0.85		V
Max. Forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	I _{FSM}	50							A
Max.Reverse current	V _R =V _{RRM} T _J =25°C	I _R	0.5						mA
	V _R =V _{RRM} T _J =100°C		10						
Typ. Thermal resistance (Junction to ambient)	R _{θJA}	85							°C/W
Typ. Diode Junction capacitance (Note 1)	C _J	160							pF
Operating temperature	T _J	-55 to +125			-55 to +150				°C
Storage temperature range	T _{STG}	-65 to +175							°C

Note : 1. $F=1\text{MHz}$ and applied 4V DC reverse voltage